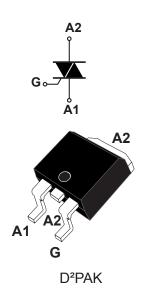




Datasheet

12 A - 800 V - 150 °C 8H Triac in D²PAK





Product status link				
T1235H-8G				
Product summary				
I _{T(RMS)}	12 A			
V _{DRM} /V _{RRM}	800 V			
V _{DSM} /V _{RSM}	900 V			
I _{GT}	35 mA			
T _j max.	150 °C			

Features

- 12 A medium current Triac
- 800 V symmetrical blocking voltage
- 150 °C maximum junction temperature T_i
- Three triggering quadrants
- High noise immunity static dV/dt
- Robust dynamic turn-off commutation (dl/dt)c
- ECOPACK2 compliant component
- Molding resin UL94-V0 flammability certified

Applications

- General purpose AC line load control
- AC induction and universal motor control
- Lighting and automation I/O control
- Water heater, room heater and coffee machine
- Home automation smart AC plug
- Inrush current limiter in AC DC rectifiers

Description

Specifically designed to operate at 800 V and 150 °C, the T1235H-8G Triac housed in D²PAK provides an enhanced thermal management: this 12 A Triac is the right choice for a compact drive of AC loads and enables the heatsink size reduction.

D²PAK package is ideal for compact SMD designs on surface mount boards or insulated metal substrate boards.

Based on the ST high temperature Snubberless technology, it offers higher specified turn off commutation and noise immunity levels up to the T_j max.

The T1235H-8G safely optimizes the control of the hardest universal motors, heaters and inductive loads for industrial control and home appliances.

Snubberless is a trademark of STMicroelectronics.

1 Characteristics

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Symbol	Parameter	Value	Unit	
I _{T(RMS)}	RMS on-state current (full sine wave)	12	А	
	Non repetitive surge peak on-state current (full cycle,	current (full cycle, t = 16.7 ms		А
ITSM	T _j initial = 25 °C)	t = 20 ms	120	A
l ² t	I ² t value for fusing	t _p = 10 ms	95	A ² s
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, tr \leq 100 ns, f = 100 Hz	100	A/µs	
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage	800	V	
V _{DSM} /V _{RSM}	Non Repetitive peak off-state voltage	900	V	
I _{GM}	Peak gate current	4	А	
P _{GM}	$t_p = 20 \ \mu s, \ T_j = 150 \ ^\circ C$ Maximum gate power dissipation		5	W
P _{G(AV)}	Average gate power dissipation $T_j = 150 \text{ °C}$		1	W
T _{stg}	Storage temperature range	-40 to +150	°C	
Тj	Operating junction temperature range	-40 to +150	°C	

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions	Quadrants		Value	Unit		
I _{GT}	I_{GT} $V_{D} = 12 V. R_{I} = 30 \Omega$			- -	Min.	5	mA
G	VD = 12 V, IXL = 30 M		1 - 11 - 111	Max.	35	mA	
V _{GT}	V_D = 12 V, R_L = 30 Ω	V _D = 12 V, R _L = 30 Ω		Max.	1.3	V	
V _{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	T _j = 150 °C	1 - 11 - 111	Min.	0.15	V	
I_L $I_G = 1.2 \times I_{GT}$		I - III	Max.	50	mA		
		II	Max.	80	mA		
I _H ⁽¹⁾	I _T = 500 mA, gate open		Max.	35	mA		
dV/dt (1)	$V_D = V_R = 536 V$, gate open		T _j = 150 °C	Min.	2000	V/µs	
(dl/dt)c (1)	Without snubber network		T _j = 150 °C	Min.	12	A/ms	

1. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	Test conditions	Tj		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 17 A, t _p = 380 μs	25 °C	Max.	1.50	V
V _{TO} ⁽¹⁾	Threshold voltage	150 °C	Max.	0.80	V
R _D ⁽¹⁾	Dynamic resistance	150 °C	Max.	32	mΩ
	$V_{\rm D} = V_{\rm R} = V_{\rm DRM} = V_{\rm RRM}$	25 °C	Max.	2.0	μA
I _{DRM} /I _{RRM}	$\nabla D = \nabla R = \nabla D R M = \nabla R R M$	150°C	Wax.	4.5	mA
	$V_D = V_R = 400 V$, peak voltage	150 °C	Max.	1.7	mA

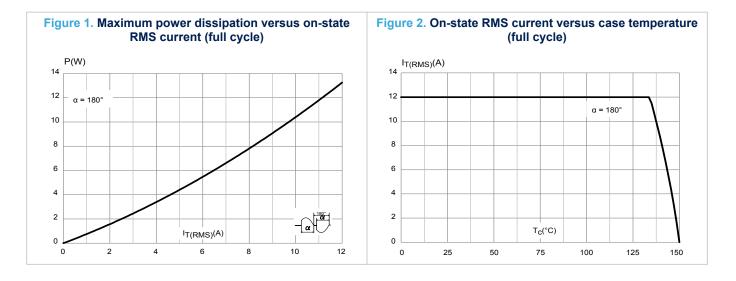
1. For both polarities of A2 referenced to A1.

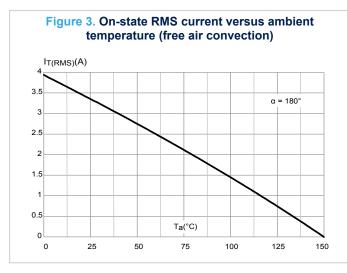
Table 4. Thermal resistance

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case (AC)	Max.	1.1	°C/W
R _{th(j-a)}	Junction to ambient ($S_{CU}^{(1)}$ = 2 cm ²)	Тур.	45	°C/W

1. Scu : copper pad surface under tab, 35 µm copper thickness on FR4 PCB.

1.1 Characteristics (curves)





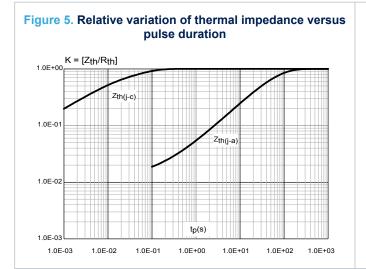
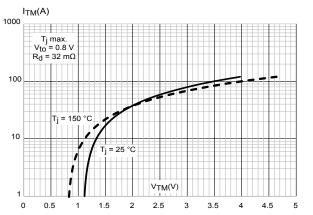
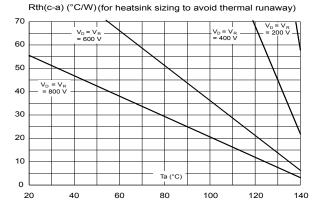


Figure 4. On-state characteristics (maximum values)











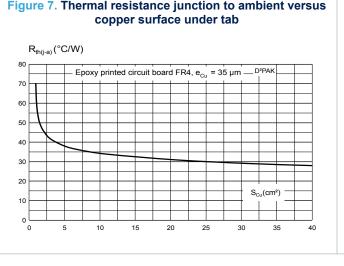
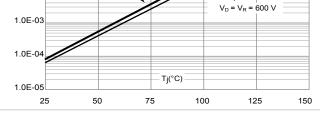


Figure 7. Thermal resistance junction to ambient versus



V_D = V_R = 800 V

Figure 8. Relative variation of leakage current versus

junction temperature for different values of blocking

voltage

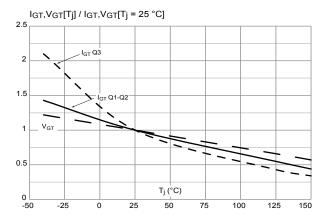
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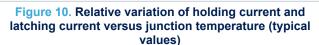
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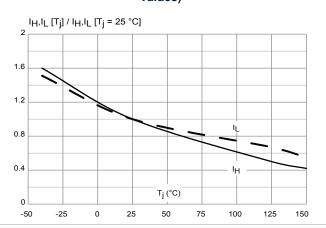
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IDRM/IRRM [Tj, VDRM/VRRM] / IDRM/IRRM [Tj max.,800 V]

Figure 9. Relative variation of gate trigger voltage and current versus junction temperature (typical values)







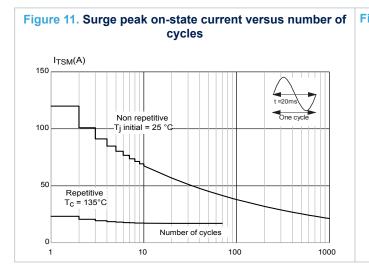
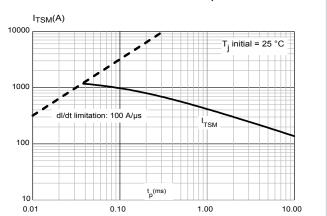
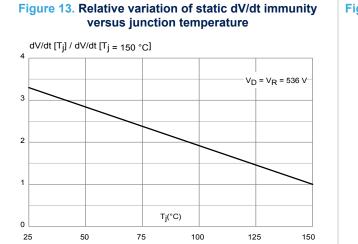
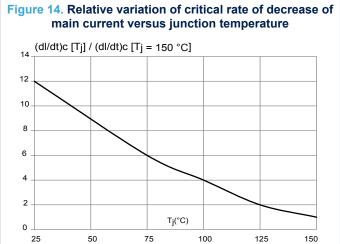


Figure 12. Non repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10 ms











2 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

- ECOPACK2 compliant
- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 flammability standard level V0

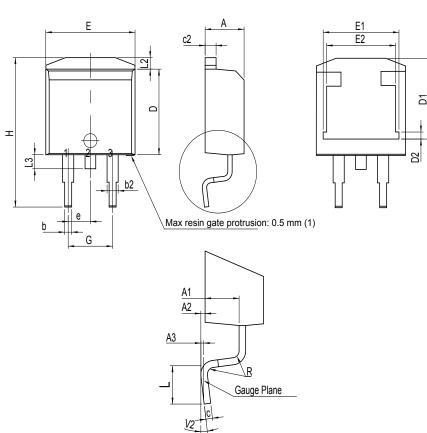


Figure 15. D²PAK package outline

(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

				Dimensions		
Ref.		Millimeters			Inches ⁽¹⁾	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
С	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
е	2.54			0.10000		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
Н	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0468		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2 ⁽²⁾	0°		8°	0°		8°

Table 5. D²PAK package mechanical data

1. Dimensions in inches are given for reference only

2. Degrees

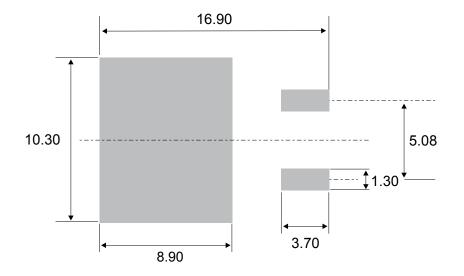
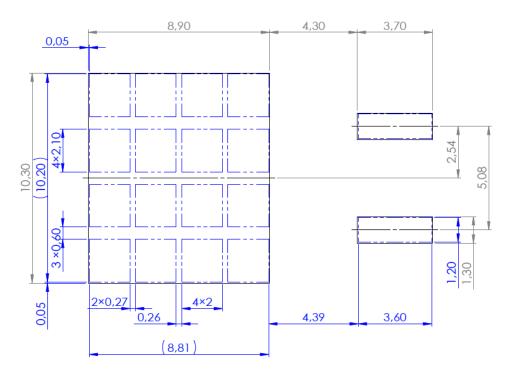


Figure 16. D²PAK recommended footprint (dimensions are in mm)

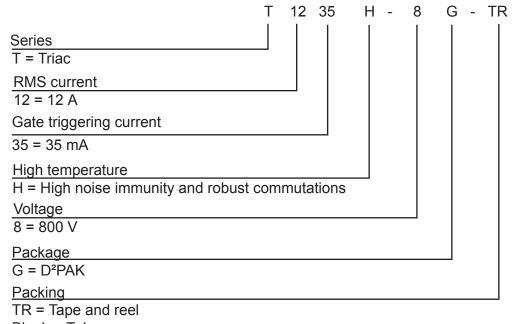




3 Ordering information

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Figure 18. Ordering information scheme



Blank = Tube

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T1235H-8G-TR	T1235H-8G		160	1000	Tape and reel 13"
T1235H-8G	112330-66	D ² PAK	1.6 g	50	Tube

Revision history

Date	Version	Changes
20-Nov-2020	1	Initial release.
16-Dec-2020	2	Updated general description. Inserted STPOWER logo.

Table 7. Document revision history

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